

MOSFET Maximum Ratings T₁ = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		-40	V	
V _{GS}	Gate-to-Source Voltage		±20	V	
	Drain Current - Continuous (T _C < 90°C, V _{GS} =10)	(Note 1)	-32	•	
D	Pulsed Drain Current		See Figure 4	— A	
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	121	mJ	
D	Power Dissipation		83	W	
P _D	Derate Above 25°C		0.56	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.8	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)		40	°C/W	

Package Marking and Ordering Information

Device Marking) Device	Package	Reel Size	Tape Width	Quantity
FDD4685	FDD4685_F085	D-PAK(TO-252)	13"	12mm	2500units

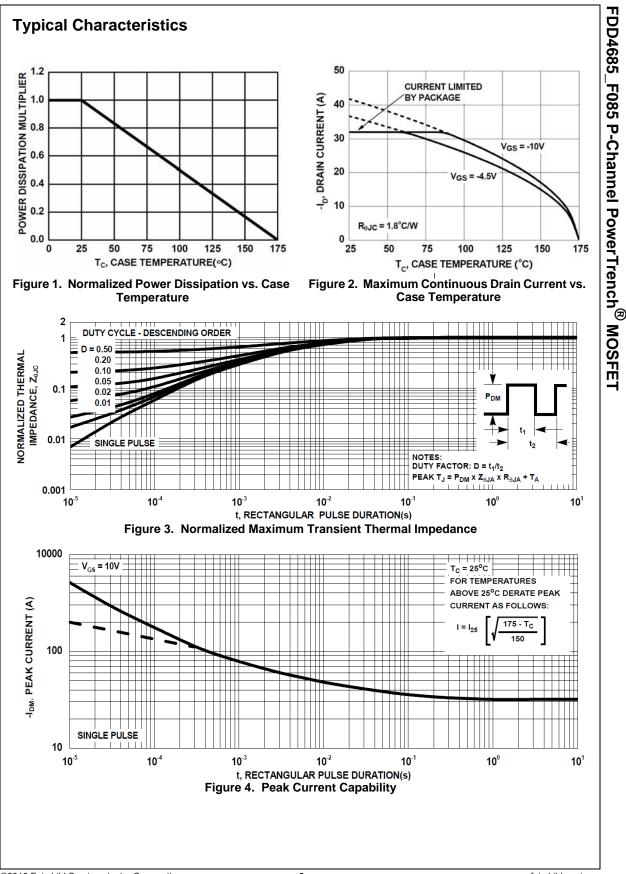
Notes:

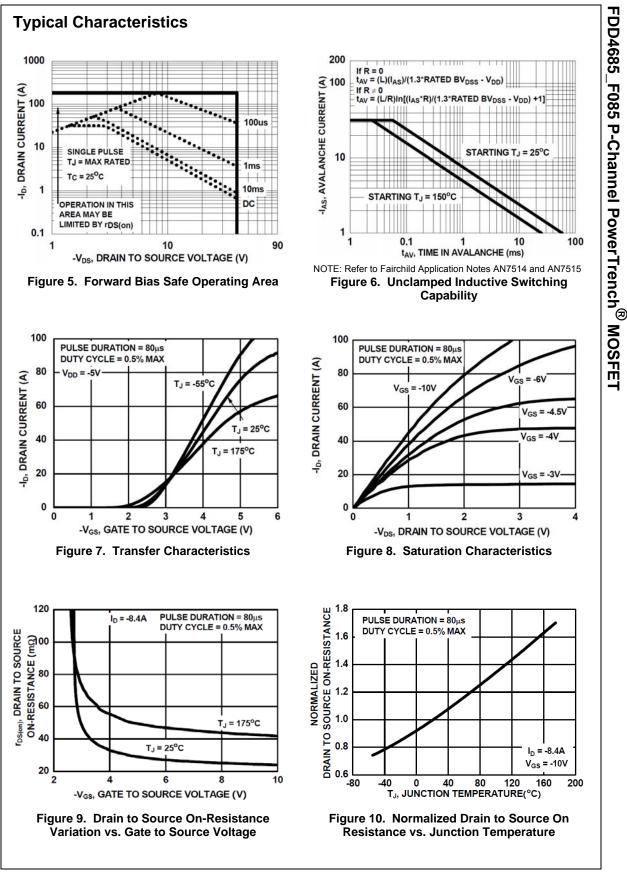
1. Current is limited by bondwire configuration.

2. Starting T_J = 26°C, L = 3mH, I_{AS} = 9A, V_{DD} = 40V during inductor charging and V_{DD} = 0V during time in avalanche. 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,JC}$ is guaranteed by design, while $R_{\theta,JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 202 copper.

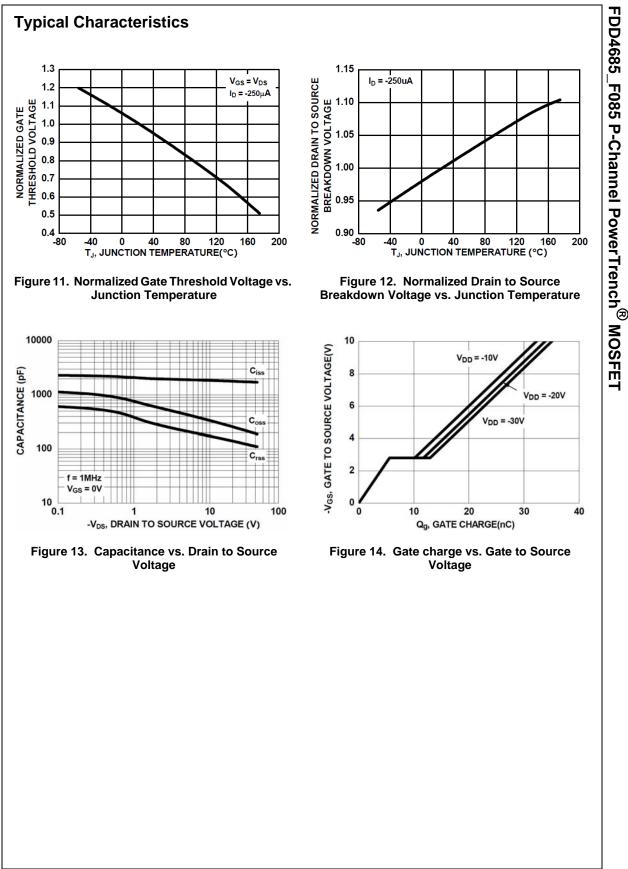
4. A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-40	-	-	V	
$\frac{\Delta B_{VDSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	ID = -250 μ A, referenced to 25°C	-	-33	-	mV/ºC	
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = -32V	-	-	-1	μA	
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$	-	-	±100	nA	
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250μA	-1	-1.6	-3	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	ID = -250μ A, referenced to 25° C	-	4.9	-	mV/ºC	
		I _D = -8.4A, V _{GS} = -10V	-	23	27		
R _{DS(on)}	Drain to Source On Resistance	I _D = -7A, V _{GS} = -4.5V	-	30	35	mΩ	
		I_D = -8.4A, V_{GS} = -10V, T_J = 150°C	-	38	45		
9 _{FS}	Forward Transconductance	ID = -8.4A, VDS = -5V	-	23	-	S	
-	ic Characteristics			4700	0000		
C _{iss}	Input Capacitance	– V _{DS} = -20V, V _{GS} = 0V,	-	1790	2380	рF	
C _{oss}	Output Capacitance	f = 1MHz	-	260	345	pF	
C _{rss}	Reverse Transfer Capacitance Gate Resistance	f = 1MHz	-	140 4	205	pF Ω	
R _g	Total Gate Charge	T - TMHZ	-	4 19	- 27	nC	
Q _{g(ToT)}	Gate-to-Source Gate Charge	– V _{DD} = -20V, V _{GS} = -5V,	-	5.6	-	nC	
Q _{gs} Q _{gd}	Gate-to-Drain "Miller" Charge	I _D = -8.4A		6.1	-	nC	
	ng Characteristics						
+	Turn-On Delay		-	8	16	ns	
t _{d(on)} t _r	Rise Time		-	15	27	ns	
	Turn-Off Delay	V _{DD} = -20V, I _D = -8.4A, V _{GS} = -10V, R _{GEN} = 6Ω		34	55	ns	
t _{d(off)} t _f	Fall Time			14	26	ns	
-	ource Diode Characteristics						
V _{SD}	Source-to-Drain Diode Voltage	I _{SD} = -8.4A, V _{GS} = 0V	-	-0.85	-1.2	V	
t _{rr}	Reverse-Recovery Time	— I _{SD} = -8.4A, dI _{SD} /dt = 100A/μs	-	30	45	ns	
Q _{rr}	Reverse-Recovery Charge	ISD 0.47 (, algD/at 100/ vµo	-	31	47	nC	





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